device 10 according to this embodiment comprises a pair of mutually opposing thin plate sections 12a, 12b made of metal, a fixation section 14 for supporting the thin plate sections 12a, 12b, and an object 18 allowed to intervene between forward end portions of the pair of thin plate sections 12a, 12b. The piezoelectric/electrostrictive device 10 further comprises piezoelectric/electrostrictive elements 20a, 20b which are arranged on outer surfaces (hereinafter referred to as "side surfaces") of the pair of thin plate sections 12a, 12b respectively. The piezoelectric/electrostrictive device 10 is operated such that the object is displaced in accordance with the driving of the piezoelectric/electrostrictive element or elements 20a and/or 20b.

The object 18 is bonded by the aid of an adhesive 100 between the forward end portions of the respective thin plate sections 12a, 12b. The fixation section 14 is bonded by the aid of an adhesive 102 between rearward end portions of the respective thin plate sections 12a, 12b.

The piezoelectric/electrostrictive elements 20a, 20b are prepared as separate members, and the prepared piezoelectric/electrostrictive elements 20a, 20b are secured to the side surfaces of the thin plate sections 12a, 12b respectively with the adhesive 104. Those usable as the adhesives 100, 102, 104 include, for example, organic resin, glass, brazing material, and soldering glass.

The piezoelectric/electrostrictive element 20a, 20b